

Notice of References Cited	Application/Control No. 10/764,023	Applicant(s)/Patent Under Reexamination PARK ET AL.	
	Examiner Jacques M. Saint-Surin	Art Unit 2856	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-5,932,953	08-1999	Drees et al.	310/324
	B	US-4,312,228	01-1982	Wohltjen, Henry	73/597
	C	US-6,668,618	12-2003	Larson et al.	73/24.01
	D	US-6,651,488	11-2003	Larson et al.	73/61.62
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	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
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	R					
	S					
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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	US 2002/0017138 A1, Ueyanagi et al. Semiconductor sensor chip and method for producing the chip, and semiconductor sensor and package for assembling the sensor.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.